

To our customers,

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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2SJ186

Silicon P Channel MOS FET

REJ03G0849-0200
(Previous: ADE-208-1184)
Rev.2.00
Sep 07, 2005

Description

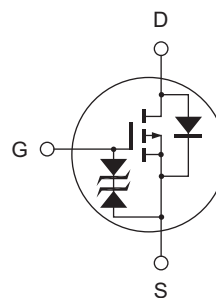
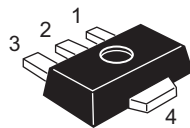
High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

Outline

RENESAS Package code: PLZZ0004CA-A
(Package name: UPAK[®])



1. Gate
2. Drain
3. Source
4. Drain

Note: Marking is "CY".

*UPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V_{DSS}	-200	V
Gate to source voltage	V_{GSS}	±15	V
Drain current	I_D	-0.5	A
Drain peak current	$I_{D (pulse)}$ ^{Note 1}	-1.0	A
Body to drain diode reverse drain current	I_{DR}	-0.5	A
Channel dissipation	P_{ch} ^{Note 2}	1	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$

2. When using the alumina ceramic board (12.5 × 20 × 0.7 mm)

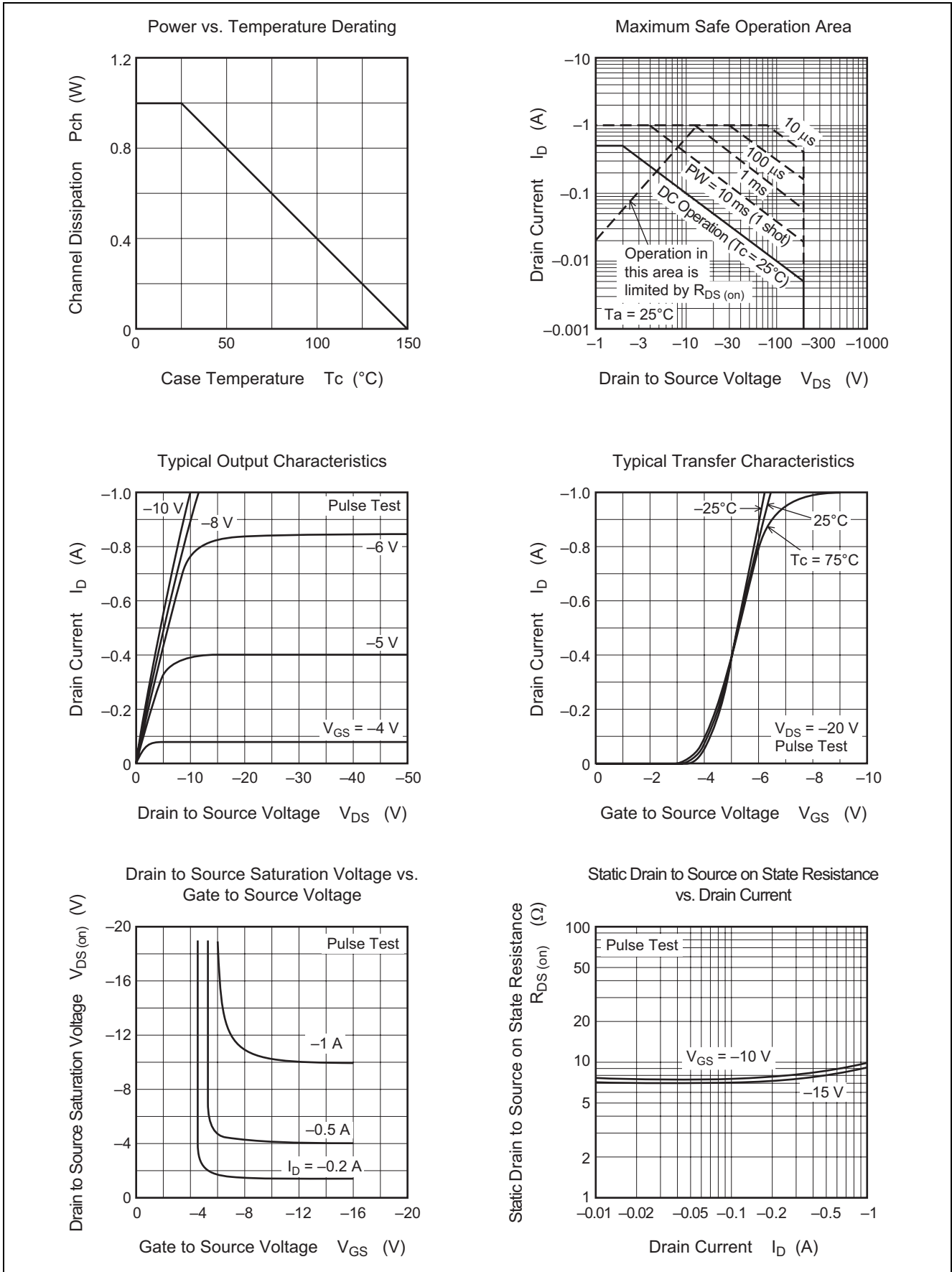
Electrical Characteristics

(Ta = 25°C)

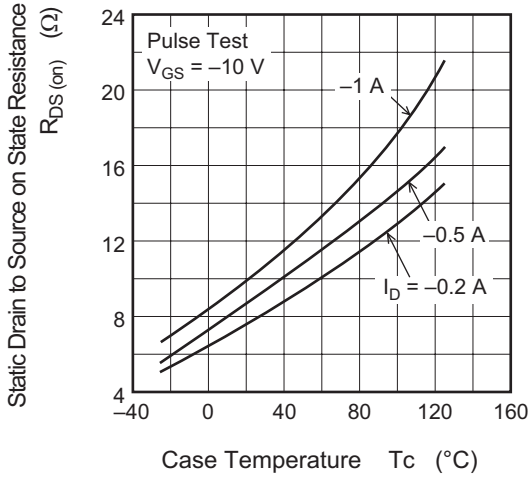
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR) DSS}$	-200	—	—	V	$I_D = -10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR) GSS}$	±15	—	—	V	$I_G = \pm 100 \mu A$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 12 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-50	μA	$V_{DS} = -160 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS (off)}$	-2.0	—	-4.0	V	$I_D = -1 \text{ mA}$, $V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS (on)}$	—	8.0	12.0	Ω	$I_D = -0.25 \text{ A}$, $V_{GS} = -10 \text{ V}$ ^{Note 3}
	$R_{DS (on)}$	—	10.0	15.0	Ω	$I_D = -1 \text{ A}$, $V_{GS} = -10 \text{ V}$ ^{Note 3}
Forward transfer admittance	$ y_{fs} $	0.18	0.3	—	S	$I_D = -0.25 \text{ A}$, $V_{DS} = -10 \text{ V}$ ^{Note 3}
Input capacitance	C_{iss}	—	75	—	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	C_{oss}	—	32	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	5	—	pF	$f = 1 \text{ MHz}$
Turn-on delay time	$t_{d (on)}$	—	6	—	ns	$I_D = -0.25 \text{ A}$
Rise time	t_r	—	6	—	ns	$V_{GS} = -10 \text{ V}$
Turn-off delay time	$t_{d (off)}$	—	17	—	ns	$R_L = 120 \Omega$
Fall time	t_f	—	15	—	ns	
Body to drain diode forward voltage	V_{DF}	—	0.95	—	V	$I_F = -0.5 \text{ A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	100	—	ns	$I_F = -0.5 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu s$

Note: 3. Pulse test

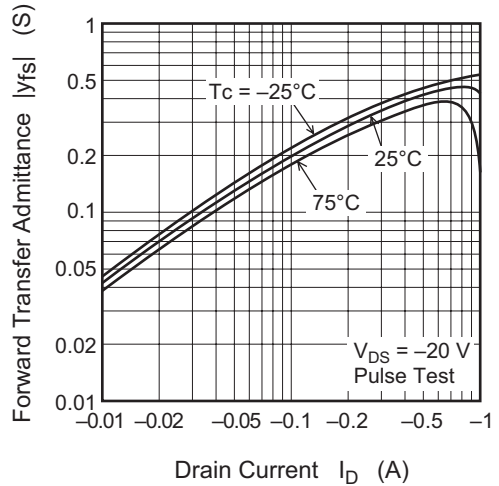
Main Characteristics



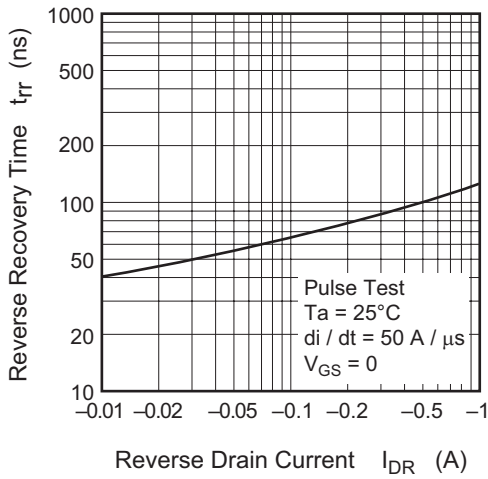
Static Drain to Source on State Resistance vs. Temperature



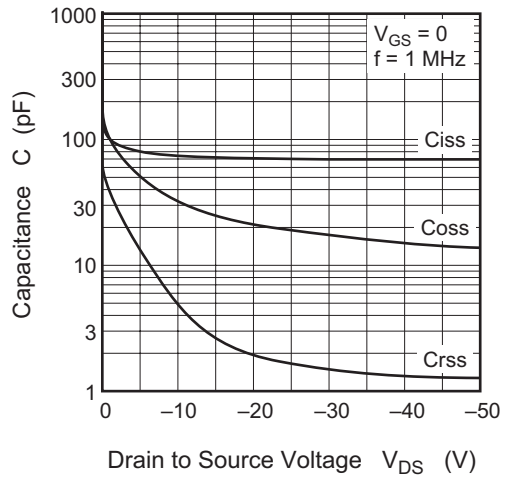
Forward Transfer Admittance vs. Drain Current



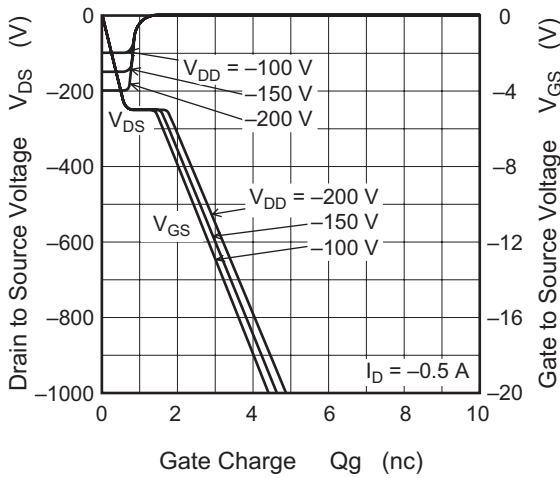
Body-Drain Diode Reverse Recovery Time



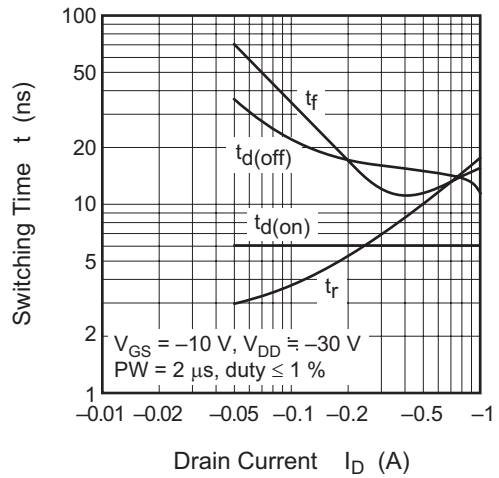
Capacitance vs. Drain to Source Voltage

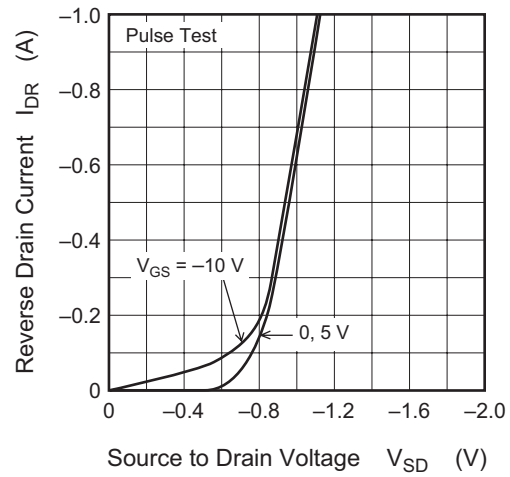


Dynamic Input Characteristics

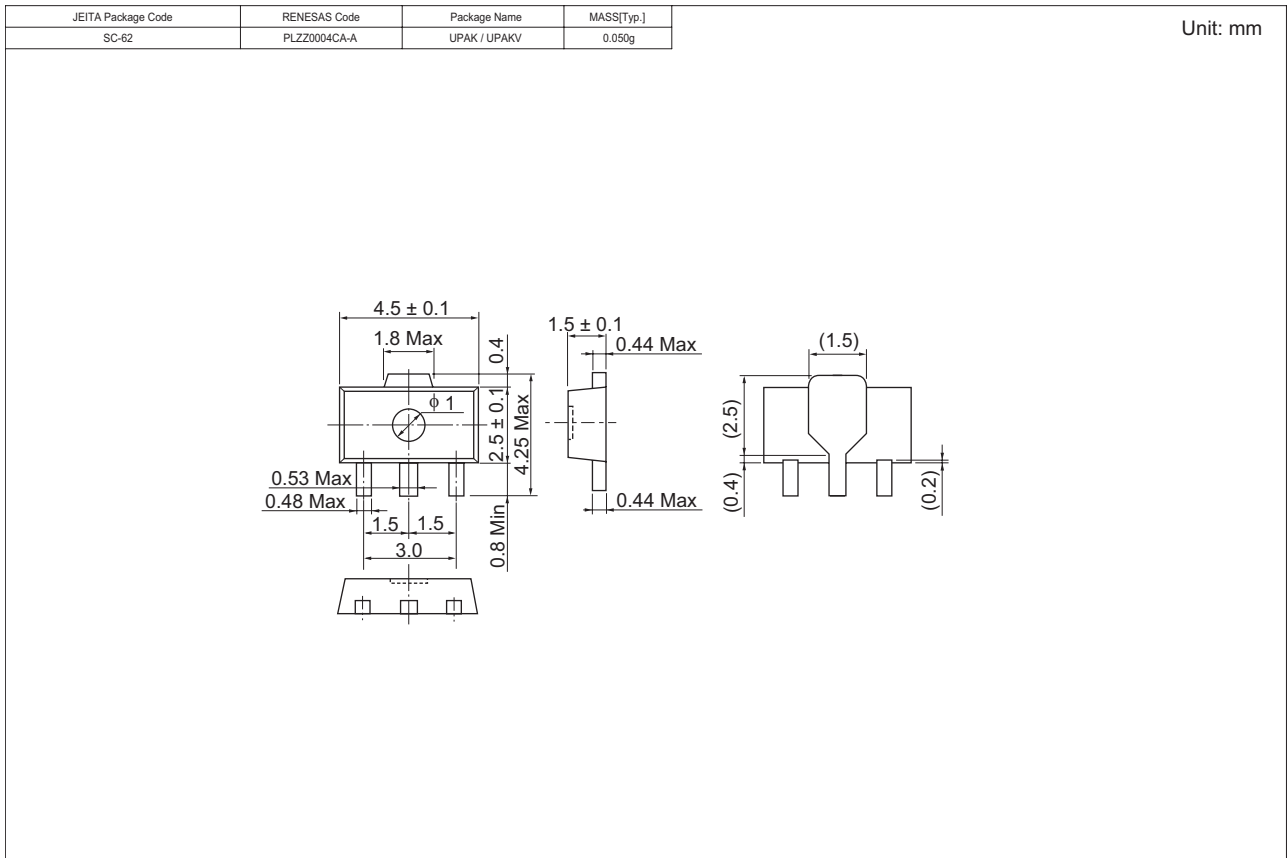


Switching Characteristics



Reverse Drain Current vs.
Source to Drain Voltage

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SJ186CYEL-E	1000 pcs	$\phi 178$ mm Reel, 12 mm Emboss Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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